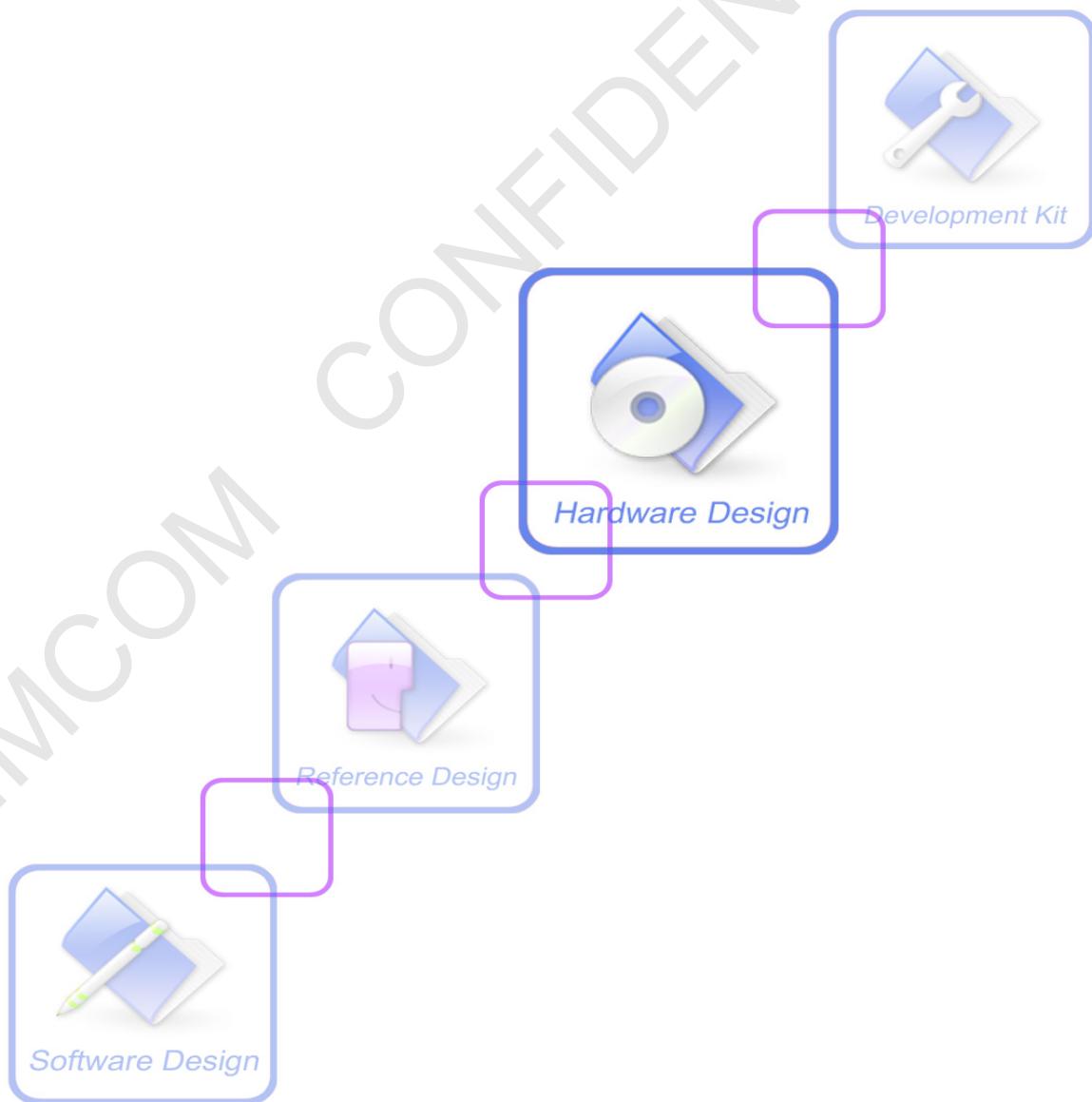




A company of SIM Tech

Application Note

**SIM800F_SIM900_SIM5300EA_Migration to
SIM7000_Application Note_V1.00**



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Contents

| | |
|--|-----------|
| Contents | 3 |
| Table Index | 4 |
| Figure Index..... | 5 |
| Revision History | 6 |
| 1 Introduction | 7 |
| 2 Pin Configuration..... | 8 |
| 2.1 Pin Assignment Overview | 8 |
| 2.2 Differences of Pin Assignment Overview | 11 |
| 2.3 Differences of electronic characteristic | 12 |
| 3 Recommended Footprint..... | 13 |
| 3.1 Differences of top and bottom view | 13 |
| 3.2 Differences of recommended compatible footprint..... | 15 |
| 4 Hardware Reference Design..... | 17 |
| 4.1 Power Supply | 17 |
| 4.2 USB Interface..... | 18 |
| 4.3 Network Status Indication..... | 19 |
| 4.4 Power on/off circuit..... | 19 |
| 4.5 Reset circuit..... | 20 |
| 4.6 USIM Interface | 20 |
| 4.7 UART Interface | 21 |
| 4.8 Audio Interface..... | 22 |
| 4.9 2G/3G/4G RF Interface | 23 |
| 4.10 GNSS Application Guide | 23 |
| 4.11 Dedicated Pins..... | 24 |
| 5 Appendix | 25 |
| 5.1 Related documents | 25 |
| 5.2 Terms and Abbreviation | 25 |

Table Index

| | |
|--|----|
| Table 1: The Differences Pin Assignment | 11 |
| Table 2: The Differences of electronic characteristic..... | 12 |
| Table 3: The differences for VBAT power rang | 17 |
| Table 4: The differences for VBUS power rang | 18 |
| Table 5: The differences for UART power level..... | 21 |
| Table 6: Dedicated Pins Description for module | 24 |
| Table 7: Related documents | 25 |
| Table 8: Terms and Abbreviations | 25 |

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Figure Index

| | |
|--|----|
| Figure 1: Pin assignment overview | 8 |
| Figure 2: SIM800F pin out diagram (Top view) | 9 |
| Figure 3: SIM900 pin out diagram (Top view) | 9 |
| Figure 4: SIM5300EA pin out diagram (Top view) | 10 |
| Figure 5: Top and bottom view of SIM7000..... | 13 |
| Figure 6: SIM800F Top and bottom view | 13 |
| Figure 7: SIM900 Top, bottom and side view | 14 |
| Figure 8: SIM5300EA Top and bottom view | 14 |
| Figure 9: SIM7000 Footprint recommendation (Unit: mm)..... | 15 |
| Figure 10: SIM800F Recommended PCB footprint outline (Unit: mm)..... | 15 |
| Figure 11: SIM900 Recommended PCB footprint outline (Unit: mm) | 16 |
| Figure 12: SIM5300EA Recommended PCB footprint outline (Unit: mm)..... | 16 |
| Figure 13: Power supply reference circuit | 17 |
| Figure 14: Reference circuit of the LDO power supply | 18 |
| Figure 15: USB reference circuit | 18 |
| Figure 16: NETLIGHT/STATUS reference circuit | 19 |
| Figure 17: Power on/off reference circuit | 19 |
| Figure 18: Reset reference circuit | 20 |
| Figure 19: SIM interface reference circuit | 20 |
| Figure 20: Reference circuit of level shift | 21 |
| Figure 21 : Speaker reference circuit | 22 |
| Figure 22 : Microphone reference circuit..... | 22 |
| Figure 23: Audio codec reference circuit | 23 |
| Figure 24: Antenna matching circuit (MAIN_ANT) | 23 |
| Figure 25: Active antenna circuit | 24 |
| Figure 26: Passive antenna circuit (Default)..... | 24 |

Revision History

| Data | Version | Description of change | Author |
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| 2017-07-31 | 1.00 | Original | Tu Hongjun |

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1 Introduction

This document is targeted for customers to understand the differences between SIM7000 and SIM800F/SIM900/SIM5300EA. Users can use SIM7000, SIM800F, SIM900, and SIM5300EA module to design and develop applications quickly.

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2 Pin Configuration

2.1 Pin Assignment Overview

The following table shows the pin assignment of SIM7000 and SIM800F/SIM900/SIM5300EA.

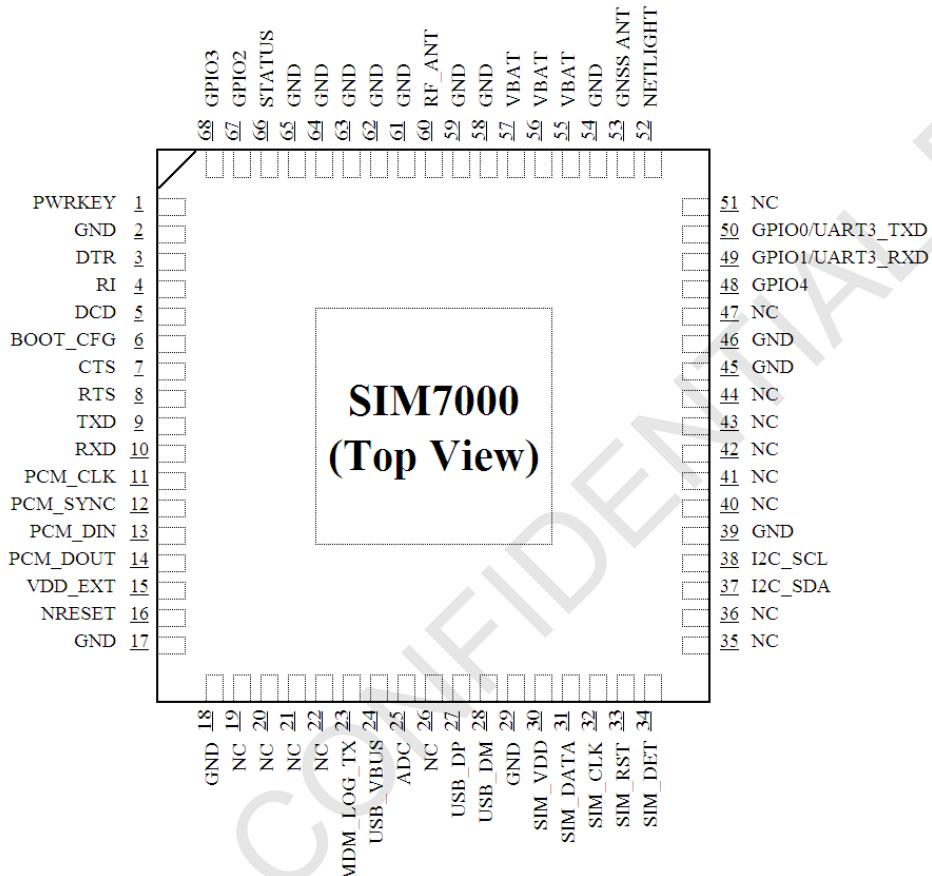


Figure 1: Pin assignment overview

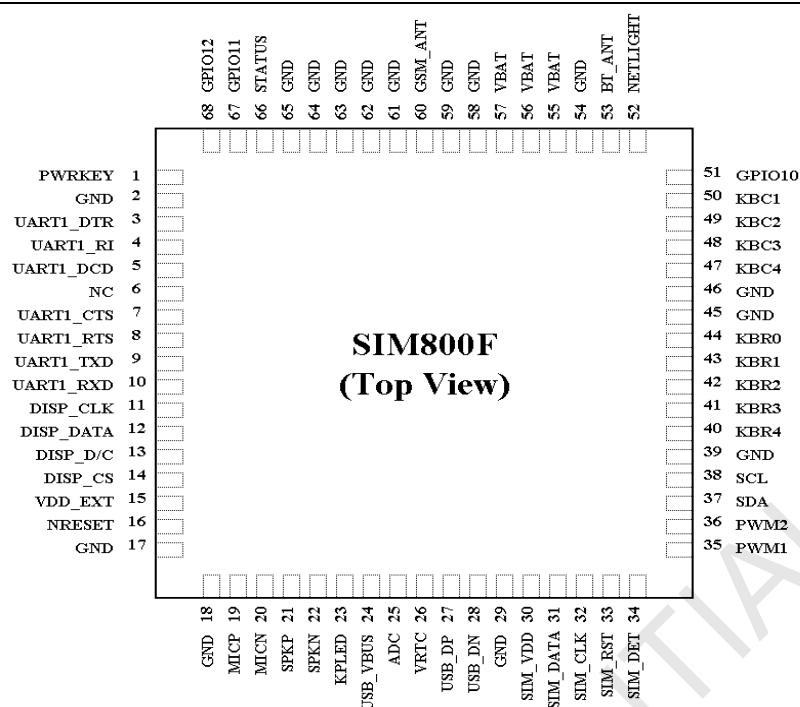


Figure 2: SIM800F pin out diagram (Top view)

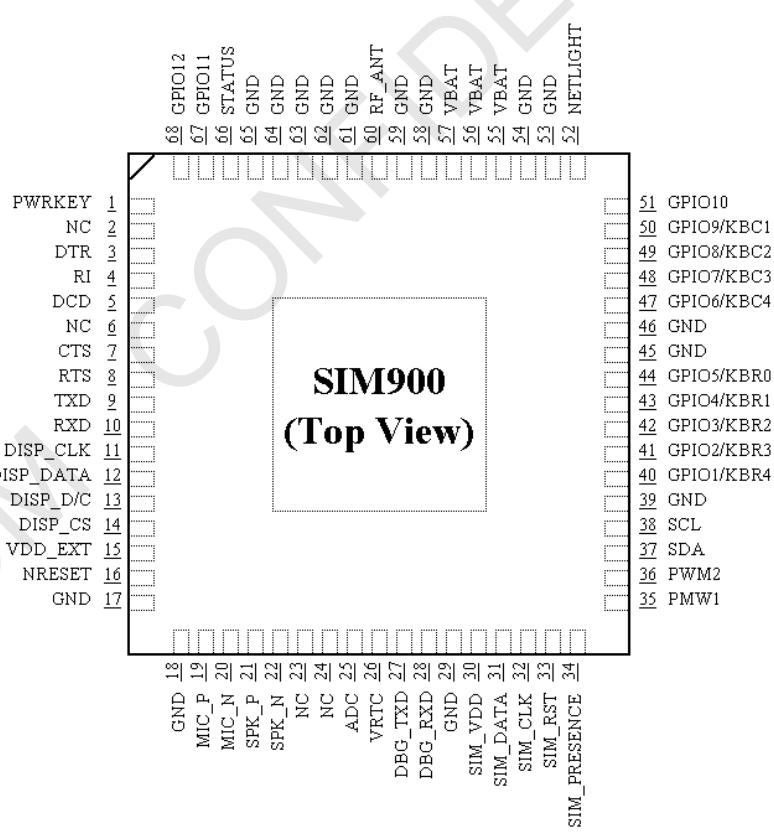


Figure 3: SIM900 pin out diagram (Top view)

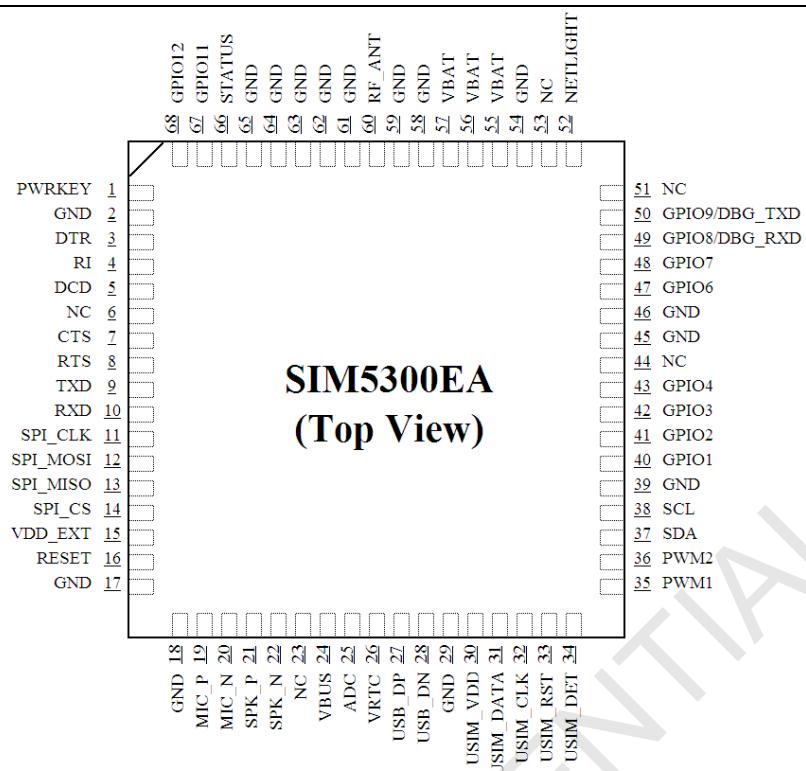


Figure 4: SIM5300EA pin out diagram (Top view)

2.2 Differences of Pin Assignment Overview

Table 1: The Differences Pin Assignment

| Pin # | SIM900 | SIM800F | SIM5300EA | SIM7000 |
|-------|------------|-----------|---------------|-----------------|
| 2 | NC | GND | GND | GND |
| 6 | NC | NC | NC | BOOT_CFG |
| 11 | DISP_CLK | DISP_CLK | SPI_CLK | PCM_CLK |
| 12 | DISP_DATA | DISP_DATA | SPI_MOSI | PCM_SYNC |
| 13 | DISP_D/C | DISP_D/C | SPI_MISO | PCM_DIN |
| 14 | DISP_CS | DISP_CS | SPI_CS | PCM_DOUT |
| 19 | MIC_P | MICP | MIC_P | NC |
| 20 | MIC_N | MICN | MIC_N | NC |
| 21 | SPK_P | SPKP | SPK_P | NC |
| 22 | SPK_N | SPKN | SPK_N | NC |
| 23 | NC | KPLED | NC | MDM_LOG_TX |
| 24 | NC | VBUS | VBUS | VBUS |
| 26 | VRTC | VRTC | VRTC | NC |
| 27 | DBG_TXD | USB_DP | USB_DP | USB_DP |
| 28 | DBG_RXD | USB_DM | USB_DM | USB_DM |
| 35 | PWM1 | PWM1 | PWM1 | NC |
| 36 | PWM2 | PWM2 | PWM2 | NC |
| 40 | GPIO1/KBR4 | KBR4 | GPIO1 | NC |
| 41 | GPIO2/KBR3 | KBR3 | GPIO2 | NC |
| 42 | GPIO3/KBR2 | KBR2 | GPIO3 | NC |
| 43 | GPIO4/KBR1 | KBR1 | GPIO4 | NC |
| 44 | GPIO5/KBR0 | KBR0 | NC | NC |
| 47 | GPIO6/KBC4 | KBC4 | GPIO6 | NC |
| 48 | GPIO7/KBC3 | KBC3 | GPIO7 | GPIO4 |
| 49 | GPIO8/KBC2 | KBC2 | GPIO8/DBG_RXD | GPIO1/UART3_RXD |
| 50 | GPIO9/KBC1 | KBC1 | GPIO9/DBG_TXD | GPIO0/UART3_TXD |
| 51 | GPIO10 | GPIO10 | NC | NC |
| 53 | GND | BT_ANT | NC | GNSS_ANT |
| 67 | GPIO11 | GPIO11 | GPIO11 | GPIO2 |
| 68 | GPIO12 | GPIO12 | GPIO12 | GPIO3 |

2.3 Differences of electronic characteristic

Table 2: The Differences of electronic characteristic

| Difference | SIM900 | SIM800F | SIM5300EA | SIM7000 |
|----------------------------|-------------|-------------|-------------------------------|---|
| Technology | GSM/GPRS | GSM/GPRS | GSM/GPRS/EDGE/ WCDMA/HSPA+ | GSM/GPRS/EDGE/eMT C (Cat-M1)/Cat-NB1 |
| VBAT | 3.2~4.8V | 3.4~4.4V | 3.4~4.4V | 3.0~4.3V |
| VBUS | Not support | 4.3~7V | 4.5~5.25V | 3.5~5.25V |
| VDD_EXT | 2.8V/10mA | 2.8V/10mA | 1.8V/50mA | 1.8V/50mA |
| I/O Level | 2.8V | 2.8V | 1.8V | 1.8V |
| ADC | 0~2.8V | 0~2.8V | 0~1.1V | 0.1~1.7V |
| VRRTC | 2.0~3.15V | 2.0~3.15V | 1.2~1.8V | Not support |
| PCM | Not support | Option | Not support | Support |
| SPI | Support | Support | Support | Option |
| GNSS | Not support | Not support | Not support | Support |
| BT | Not support | Option | Not support | Not support |
| AT communication interface | UART | UART | UART or USB | UART or USB |
| FW update interface | UART | UART or USB | USB | USB |

**Note: For details information, please refer to each HD guide*

3 Recommended Footprint

3.1 Differences of top and bottom view

The following figure shows top and bottom view of SIM7000 and SIM800F/SIM900/SIM5300EA.



Figure 5: Top and bottom view of SIM7000



Figure 6: SIM800F Top and bottom view



Figure 7: SIM900 Top, bottom and side view



Figure 8: SIM5300EA Top and bottom view

3.2 Differences of recommended compatible footprint

The following figure shows each recommended footprint of SIM7000 and SIM800F/SIM900/SIM5300EA. The differences of the recommended footprint are the keep out area and the length of the PINs. In SIM800F/SIM900, the recommendation PIN length is 1.60mm, but it is 2.00mm in SIM7000/SIM5300EA.

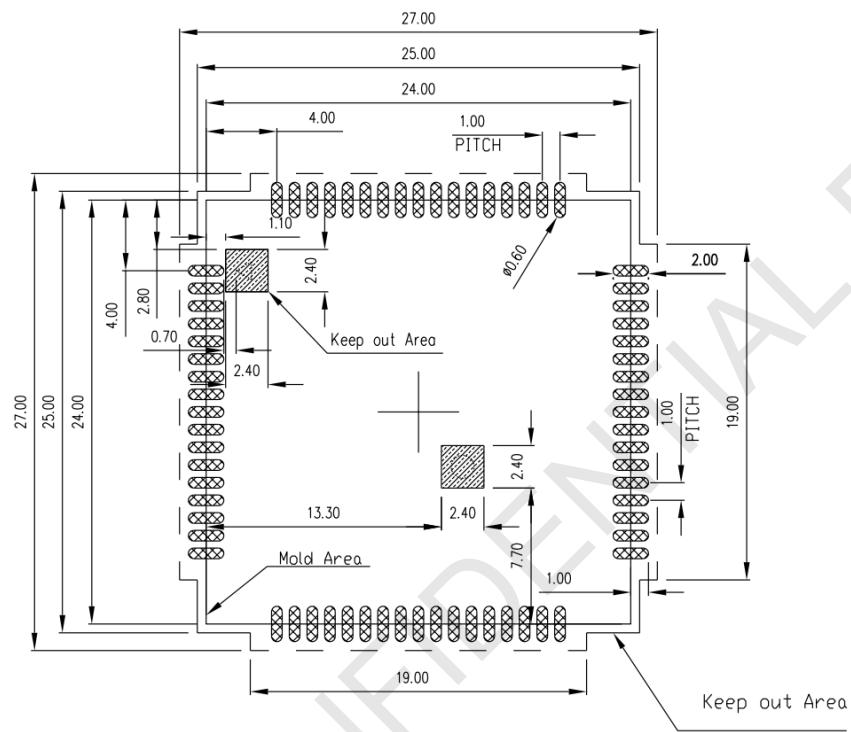


Figure 9: SIM7000 Footprint recommendation (Unit: mm)

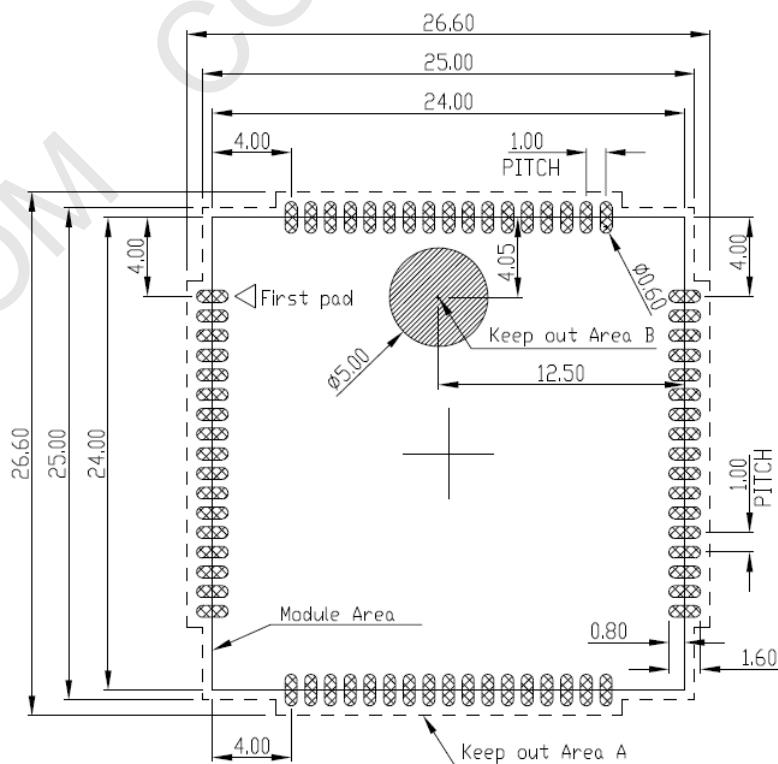


Figure 10: SIM800F Recommended PCB footprint outline (Unit: mm)

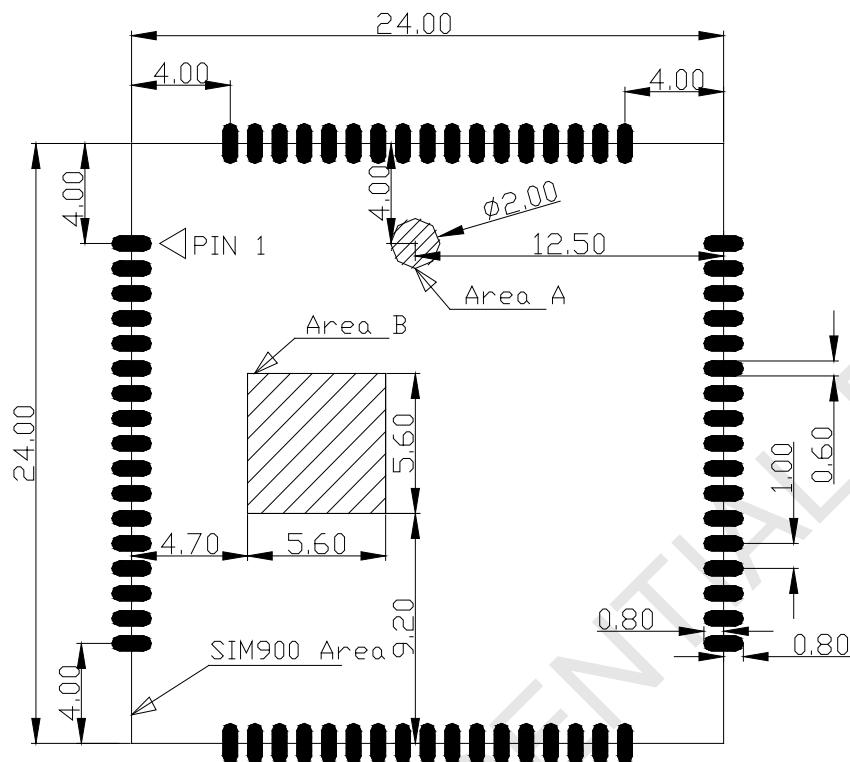


Figure 11: SIM900 Recommended PCB footprint outline (Unit: mm)

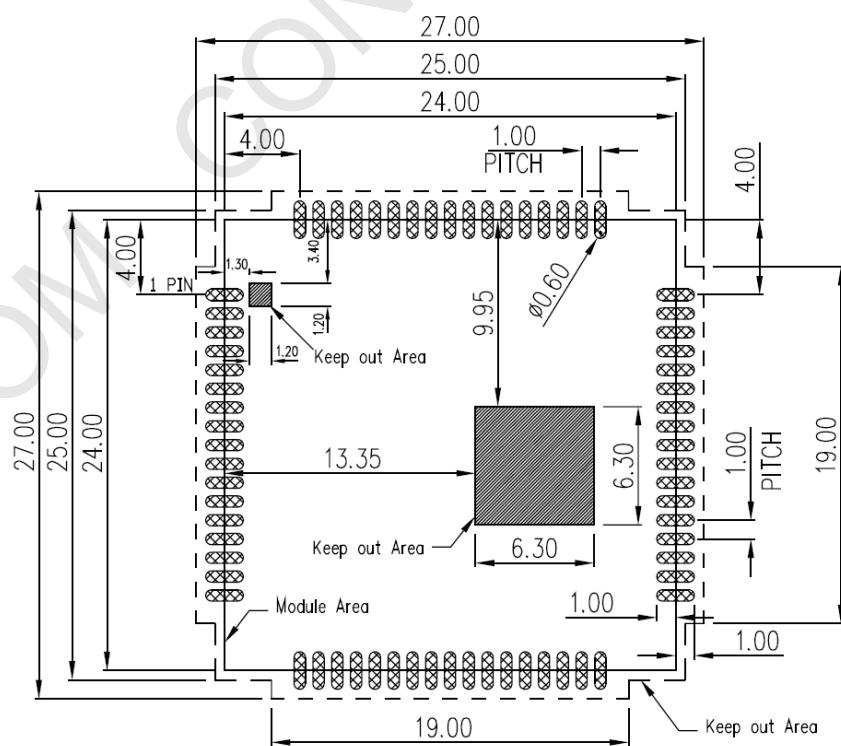


Figure 12: SIM5300EA Recommended PCB footprint outline (Unit: mm)

4 Hardware Reference Design

The following chapters describe compatible design of SIM7000 and SIM800F/SIM900/SIM5300EA on main functionalities.

4.1 Power Supply

The power supply pins of SIM7000 and SIM800F/SIM900/SIM5300EA include three VBAT pins (pin 55, 56&57). VBAT directly supplies the power to RF circuit and baseband circuit. All three VBAT pins of the module must be used together. The following figure is the reference design of the module VBAT power supply.

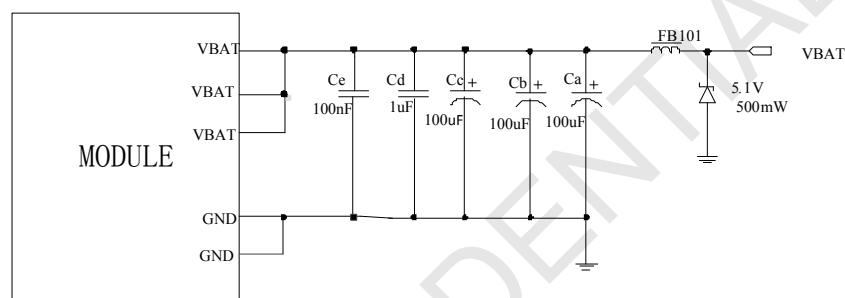


Figure 13: Power supply reference circuit

In addition, in order to get a stable power source, it is suggested to use a zener diode of which reverse zener voltage is 5.1V and dissipation power is more than 500mW.

The VBAT has different input power range for SIM7000 and SIM800F/SIM900/SIM5300EA. Please refer to the following table.

Table 3: The differences for VBAT power rang

| Project | VBAT | | |
|-----------|------|------|-------|
| | Min | Typ | Max |
| SIM900 | 3.2V | 3.8V | 4.8V |
| SIM800F | 3.4V | 3.8V | 4.4V |
| SIM5300EA | 3.4V | 3.8V | 4.4V |
| SIM7000 | 3.0V | 3.8V | 4.3V, |

*Note: For details information, please refer to each HD guide

The following figure is the reference design of +5V input power supply. The designed output for the power supply is 3.8V. A linear regulator can be used.

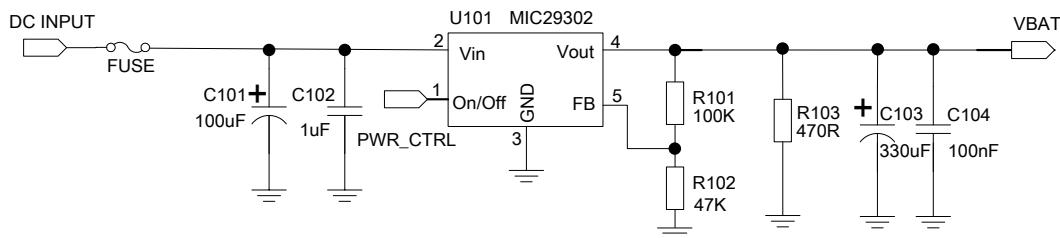


Figure 14: Reference circuit of the LDO power supply

4.2 USB Interface

The modules SIM7000 and SIM800F/ SIM5300EA provide a USB2.0 interface, but SIM900 has no USB interface.

USB device. The following circuit is the reference design of USB interface.

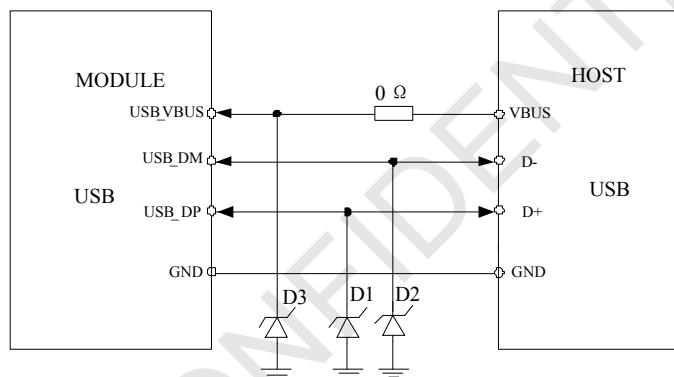


Figure 15: USB reference circuit

Because of the high speed on USB bus, more attention should be paid to the influence of the junction capacitance of the ESD component on USB data lines. Typically, the capacitance of the D1 and D2 should be less than 1pF.

The VBUS has different input power range for SIM7000 and SIM800F/SIM900/SIM5300EA. Please refer to the following table.

Table 4: The differences for VBUS power rang

| Project | VBUIS | | |
|-----------|-------------|-------------|-------------|
| | Min | Typ | Max |
| SIM900 | Not support | Not support | Not support |
| SIM800F | 4.3V | 5.0V | 7.0V |
| SIM5300EA | 4.5V | 5.0V | 5.25V |
| SIM7000 | 3.5V | 5.0V | 5.25V |

*Note: For details information, please refer to each HD guide

4.3 Network Status Indication

The NETLIGHT/STATUS pin can be used to drive a network status indicator LED. The following circuit is the reference design.

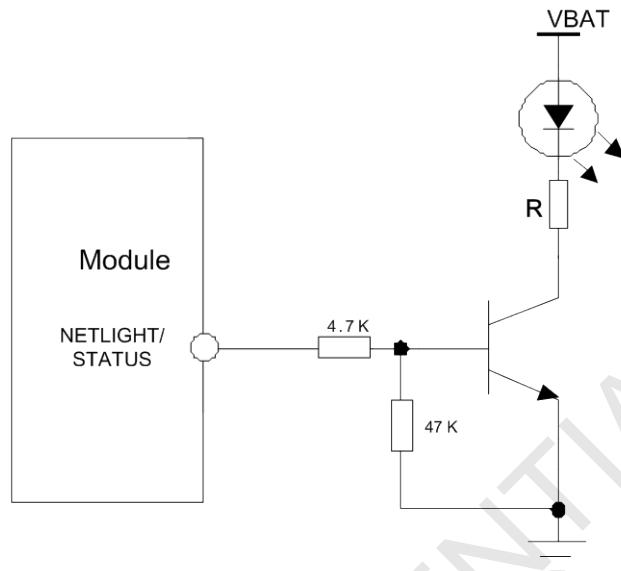


Figure 16: NETLIGHT/STATUS reference circuit

4.4 Power on/off circuit

Each module PWRKEY pin has its different power level when it is floating.

The following circuit is a reference design for SIM7000 and SIM800F/SIM900/SIM5300EA power-on/off circuit.

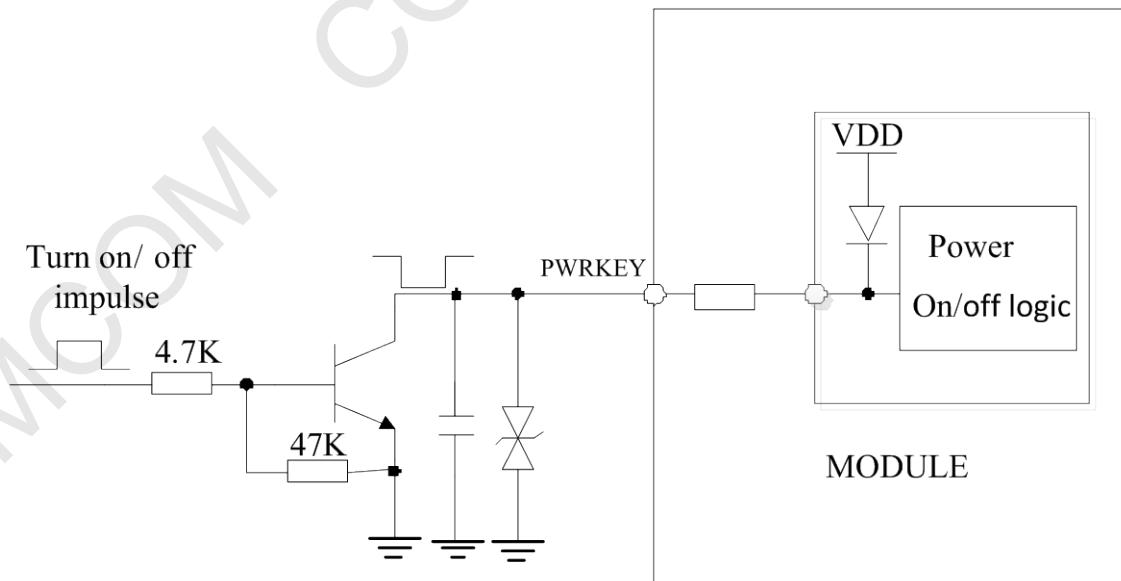


Figure 17: Power on/off reference circuit

Note: The VDD of each module in the diagram is different. For details information, please refer to each HD guide.

4.5 Reset circuit

Each module RESET pin has its different power level when it is floating.

The RESET pin has been pulled up to VDD with a resistor internally. So it does not need to be pulled up externally. It is strongly recommended to put a 100nF capacitor and an ESD protection diode close to the RESET pin. Please refer to the following figure for the recommended reference circuit.

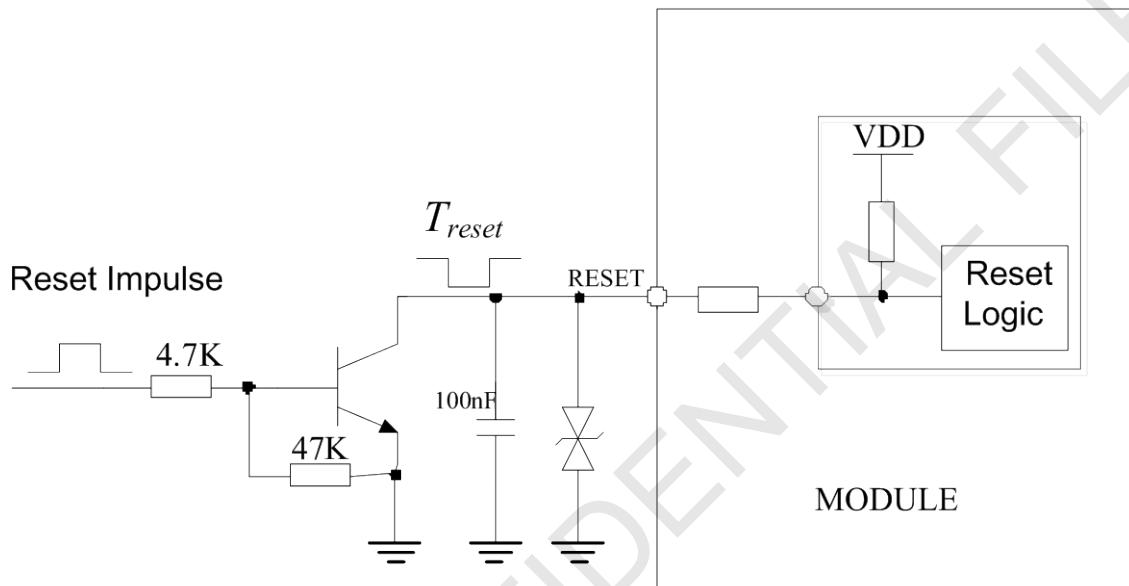


Figure 18: Reset reference circuit

Note: The VDD of each module in the diagram is different. For details information, please refer to each HD guide.

4.6 USIM Interface

The USIM provides the required subscription verification information to allow the mobile equipment to attach to a GSM or UMTS network. Both 1.8V and 3.0V SIM Cards are supported.

It is recommended to use an ESD protection component such as ST (www.st.com) ESDA6V1W5. The following circuit is a reference design for SIM7000 and SIM800F/SIM900/SIM5300EA USIM circuit.

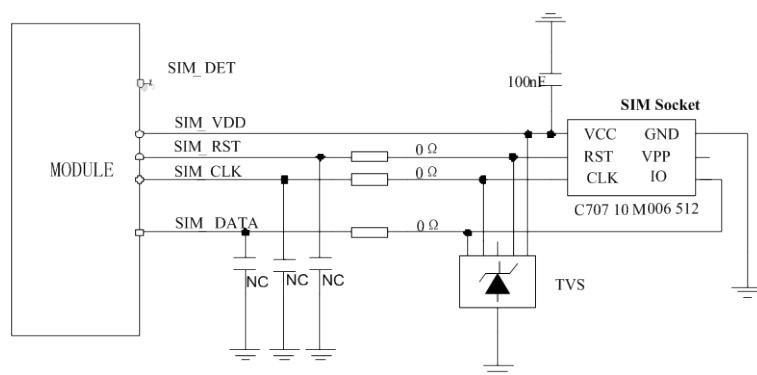


Figure 19: SIM interface reference circuit

**Note: For details information, please refer to each HD guide*

4.7 UART Interface

The power domain of each UART between SIM800F/SIM900/SIM5300EA and SIM7000 are different.

Table 5: The differences for UART power level

| PROJECT | UART power domain |
|-----------|-------------------|
| SIM900 | 2.8V |
| SIM800F | 2.8V |
| SIM5300EA | 1.8V |
| SIM7000 | 1.8V |

**Note: For details information, please refer to each HD guide*

A level shifter should be used if user's application is equipped with a 3.3V UART interface. The level shifter TXB0108RGYR provided by Texas Instruments is recommended. The reference design of the TXB0108RGYR is in the following figures

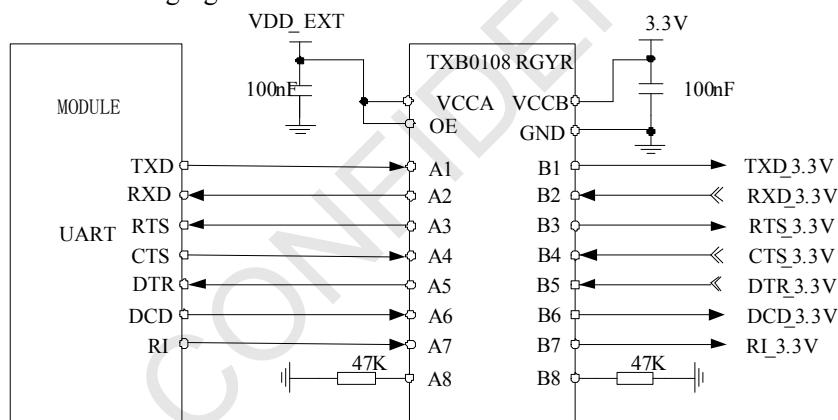


Figure 20: Reference circuit of level shift

Note: The VDD_EXT of each project in the diagram is different. For details information, please refer to each HD guide.

4.8 Audio Interface

SIM800F/SIM900/SIM5300EA provides an analog interface for audio circuit. The following circuit is the reference design.

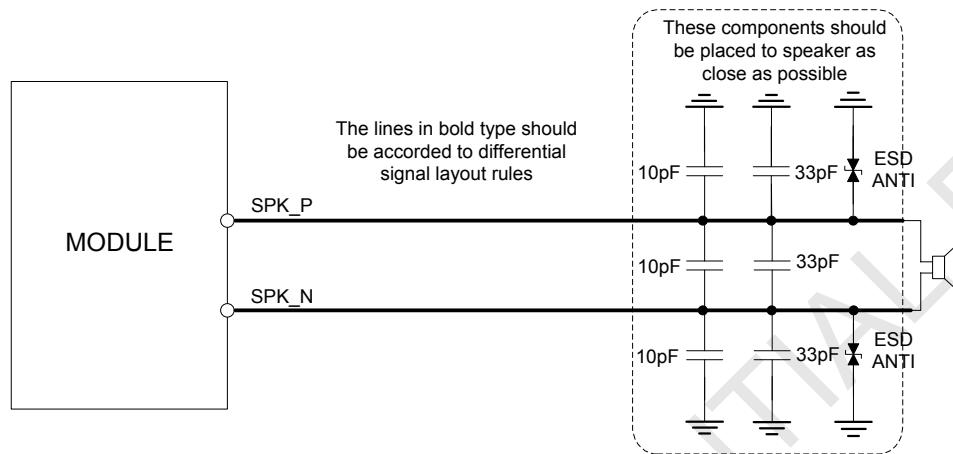


Figure 21 : Speaker reference circuit

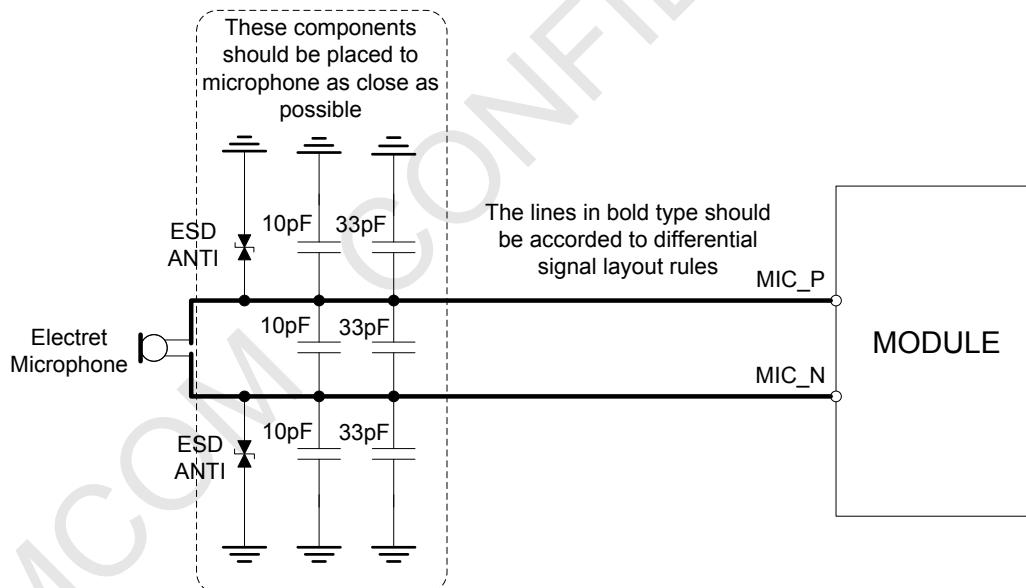


Figure 22 : Microphone reference circuit

SIM7000 provides a digital interface for audio circuit. And the digital audio interface is PCM interface, which is provided for external codec.

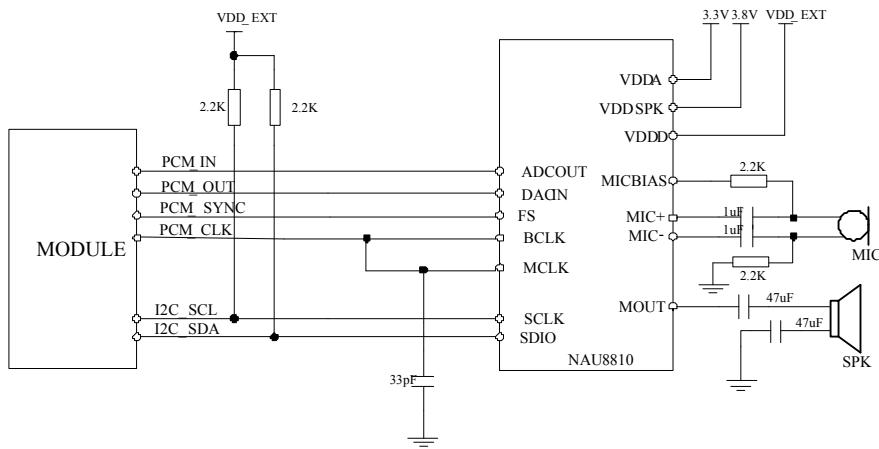


Figure 23: Audio codec reference circuit

Note: For details information, please refer to each HD guide.

4.9 2G/3G/4G RF Interface

SIM900 and SIM5300EA provide a main antenna interfaces. SIM7000 and SIM800F provide dual antenna interfaces.

Customer's antennas should be located in the host board and connected to module's antenna pad through micro-strip line or other types of RF trace and the trace impedance must be controlled by 50Ω .

The following circuit is a reference design for SIM800F/SIM900/SIM5300EA and SIM7000 RF antenna circuit.

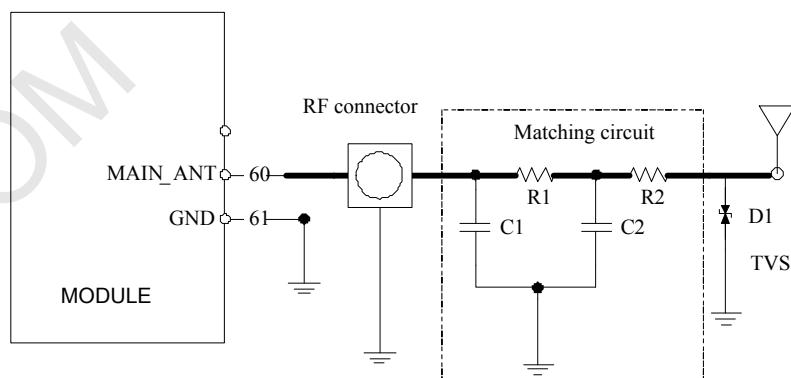


Figure 24: Antenna matching circuit (MAIN_ANT)

4.10 GNSS Application Guide

Users can adopt an active antenna or a passive antenna to SIM7000. If using a passive antenna, an

external LNA is a must to get better performance. The following figures are the reference circuits.

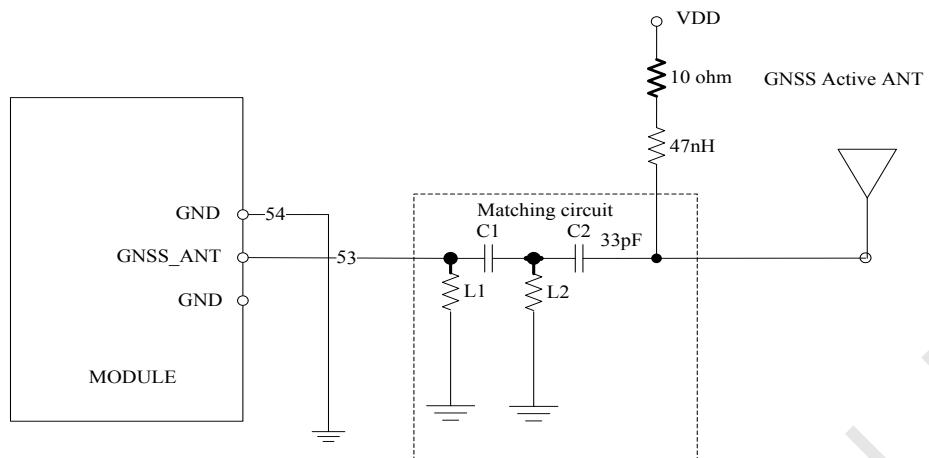


Figure 25: Active antenna circuit

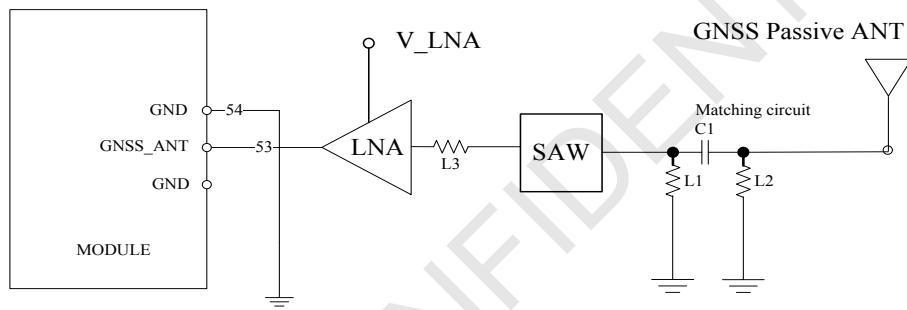


Figure 26: Passive antenna circuit (Default)

4.11 Dedicated Pins

There are some dedicated pins for SIM800F and SIM7000.

Table 6: Dedicated Pins Description for module

| SIM800F | | |
|----------|---------|--|
| Pin name | Pin No. | Function |
| KPLED | 23 | Sink current for keypad LED |
| KBC1 | 50 | Keypad column 1. It can't be pulled down during power on procedure |
| SIM7000 | | |
| Pin name | Pin No. | Function |
| BOOT_CFG | 6 | Boot configuration input. Module will be forced into USB download mode by |

| | | |
|------------|----|--|
| | | connect this pin to VDD_EXT during power up. |
| MDM_LOG_TX | 23 | Module log output for SW debug. (only used for platform) |

5 Appendix

5.1 Related documents

Table 7: Related documents

| SN | Document name | Remark |
|-----|---------------------------|------------------------------------|
| [1] | SIM7000_Hardware_Design | SIM7000 Hardware Design Document |
| [2] | SIM800F Hardware Design | SIM800F Hardware Design Document |
| [3] | SIM900 Hardware Design | SIM900 Hardware Design Document |
| [4] | SIM5300EA Hardware Design | SIM5300EA Hardware Design Document |

5.2 Terms and Abbreviation

Table 8: Terms and Abbreviations

| Abbreviation | Description |
|--------------|---|
| KPLED | Sink current for keypad LED |
| ESD | Electrostatic Discharge |
| GSM | Global Standard for Mobile Communications |
| I2C | Inter-Integrated Circuit |
| PCB | Printed Circuit Board |
| PCS | Personal Communication System, also referred to as GSM 1900 |
| RF | Radio Frequency |
| RTC | Real Time Clock |
| Rx | Receive Direction |
| SIM | Subscriber Identification Module |
| SPI | serial peripheral interface |
| UART | Universal Asynchronous Receiver & Transmitter |

| | |
|-------|--|
| VSWR | Voltage Standing Wave Ratio |
| NC | Not connect |
| EDGE | Enhanced data rates for GSM evolution |
| HSDPA | High Speed Downlink Packet Access HSUPA |
| HSDPA | High Speed Downlink Packet Access HSUPA |
| HSDPA | High Speed Downlink Packet Access HSUPA |
| USIM | Universal subscriber identity module |
| UMTS | Universal mobile telecommunications system |
| SMPS | Switch Mode Power Supply |
| KBC | Keypad Button Column KBR |
| KBR | Keypad Button Row |

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